

Electromagnetic Compatibility Society

Announcement

Financial Assistance Program for Economically Disadvantaged Engineers

The IEEE EMC Society provides funding to selected economically disadvantaged engineers from both developing and developed countries to attend the annual IEEE International Symposium on EMC (ISEMC)

Financial support is limited to basic symposium registration, excluding optional activities and services, and may also include travel and/or lodging expenses. The Financial Assistance Program for Economically Disadvantaged Engineers (FAP/EDE) committee shall determine the level of support to be provided. This committee has been formed by the IEEE EMC Society Board of Directors.

The applicant must present a technical paper in which he or she is the principal author or participate in a workshop, tutorial or demonstration that provides a substantial contribution to the conference. If there are multiple authors or presenters, only one can apply for financial assistance.

The applicant must provide two endorsements:

- (1) A co-worker/supervisor/professor and
- (2) A regional/local IEEE officer (Section Chairman, Vice Chair, Chapter Chair, etc.). The endorsement must certify that the applicant is in need of financial assistance.

The applicant must provide proof of commitment to participate at the ISEMC in addition to agreeing that they will support their IEEE Section or EMC Chapter by presenting their paper or other elements of their participation at ISEMC to fellow engineers at the local or regional level.

For questions, please contact the FAP/EDE Committee Chair by email at:

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